



P-Channel 40-V (D-S) MOSFET

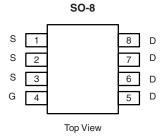
| PRODUCT SUMMARY | | | | | |
|---------------------|---|--------------------|-----------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}$ (Ω) | I _D (A) | Q _g (Typ.) | | |
| - 40 | $0.014 \text{ at V}_{GS} = -10 \text{ V}$ | - 10.5 | 40 | | |
| | 0.021 at V _{GS} = - 4.5 V | - 8.7 | 40 | | |

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

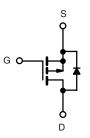






Ordering Information: Si4401BDY-T1-E3 (Lead (Pb)-free)

Si4401BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | T _A = 25 °C, unle | ss otherwise i | noted | | |
|---|-----------------------------------|------------------|----------|--------------|------|
| Parameter | | Symbol | 10 s | Steady State | Unit |
| Drain-Source Voltage | | V _{DS} | - 40 | | |
| Gate-Source Voltage | | V _{GS} | ± 20 | | V |
| Opening David Opening (T., 450,00)3 | T _A = 25 °C | - I _D | - 10.5 | - 8.7 | |
| Continuous Drain Current (T _J = 150 °C) ^a | T _A = 70 °C | | - 8.3 | - 5.9 | |
| Pulsed Drain Current | | I _{DM} | - 50 | | Α |
| Continuous Source Current (Diode Conduction) ^a | | I _S | - 2.6 | - 1.36 | |
| Avalanche Current | L = 1 mH | I _{AS} | 30 45 | | |
| Single Pulse Avalanche Energy | L=IIIII | E _{AS} | | | mJ |
| M · | T _A = 25 °C | P _D | 2.9 | 1.5 | · w |
| Maximum Power Dissipation ^a | T _A = 70 °C | | 1.85 | 0.95 | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 | to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Manipular landing to Austriant | t ≤ 10 s | R _{thJA} | 36 | 43 | °C/W |
| Maximum Junction-to-Ambient ^a | Steady State | | 70 | 84 | |
| Maximum Junction-to-Foot (Drain) | Steady State | R_{thJF} | 16 | 21 | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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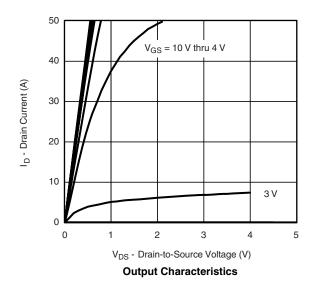
| SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted | | | | | | | |
|---|---------------------|--|-------|--------|-------|------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1.0 | | - 3.0 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| Zero Coto Valtono Duoin Comunit | 1 | V _{DS} = - 40 V, V _{GS} = 0 V | | -1 | | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$ | | | - 10 | μΑ | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 10 V | - 30 | | | Α | |
| Durin Course On Obela Desirtance | B | V _{GS} = - 10 V, I _D = - 10.5 A | | 0.011 | 0.014 | 0 | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 8.7 A | | 0.0165 | 0.021 | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 10.5 A | | 26 | | S | |
| Diode Forward Voltage ^a | V_{SD} | I _S = - 2.7 A, V _{GS} = 0 V | | - 0.74 | - 1.1 | V | |
| Dynamic ^b | | | | | | | |
| Total Gate Charge | Q_g | | | 40 | 55 | | |
| Gate-Source Charge | Q_{gs} | s V _{DS} = - 15 V, V _{GS} = - 5 V, I _D = - 10.5 A | | 10 | | nC | |
| Gate-Drain Charge | | | | 14 | | | |
| Gate Resistance | R_g | | 1.4 | 2.8 | 4.2 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 16 | 25 | | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 15 Ω | | 15 | 25 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ - 1 A, $V_{GEN} =$ - 10 V, $R_g = 6 \Omega$ | | 97 | 150 | ns | |
| Fall Time | t _f | | | 47 | 75 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = - 2.1 A, dI/dt = 100 A/μs | | 35 | 55 | | |

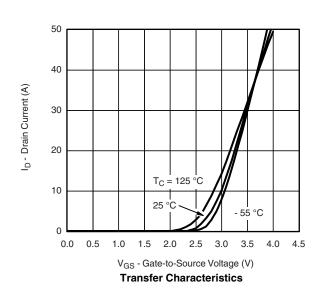
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



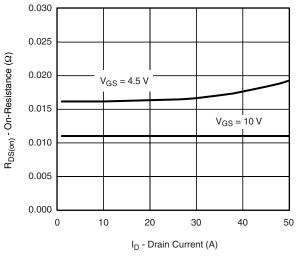




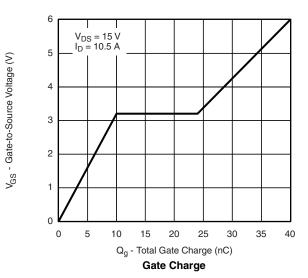


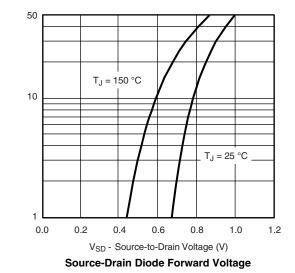


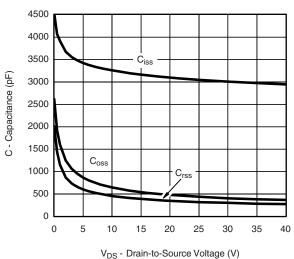
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



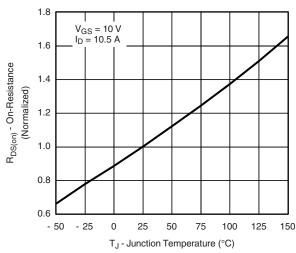
On-Resistance vs. Drain Current



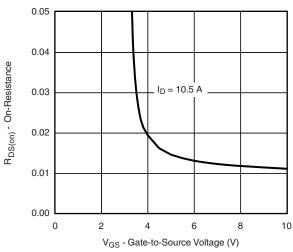




Capacitance



On-Resistance vs. Junction Temperature



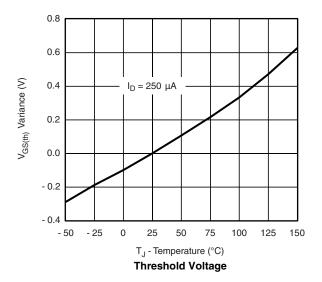
On-Resistance vs. Gate-to-Source Voltage

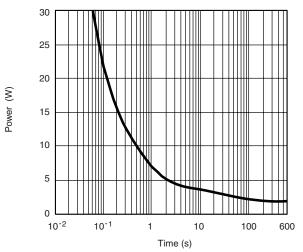
I_S - Source Current (A)

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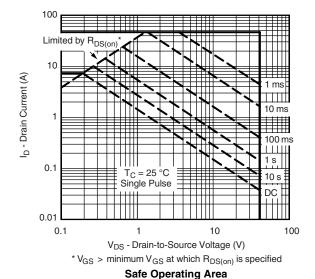
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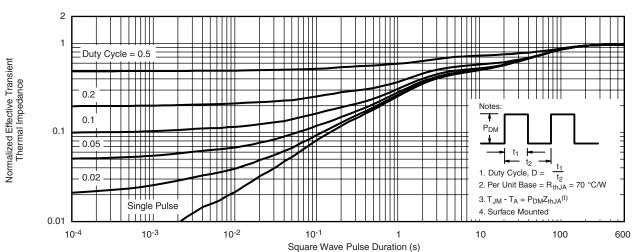
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Single Pulse Power, Junction-to-Ambient

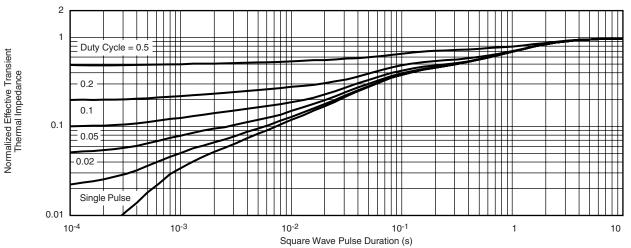




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

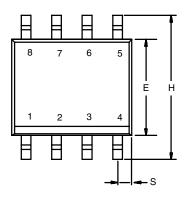


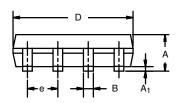
Normalized Thermal Transient Impedance, Junction-to-Foot

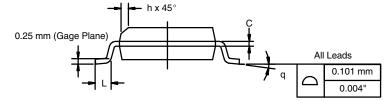
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







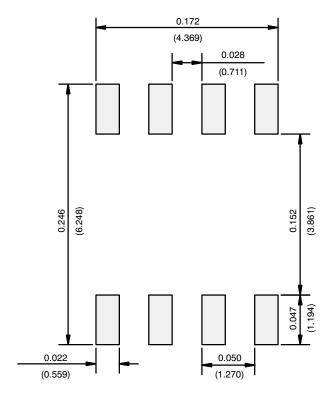
| | MILLIMETERS INCH | | | HES | | |
|--------------------------------|------------------|------|--------|-------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| Е | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 BSC | | 0.050 | 0 BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I. 11-Sep-06 | | | | | | |

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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